

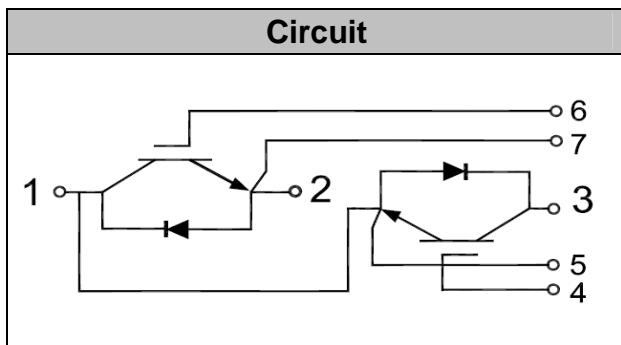
IGBT Modules



V_{CES} 1200V
I_C 200A

Applications

Industrial Inverters
Servo Applications
SMPS UPS
Induction Heating



Features

Short Circuit Rated 10 μ s
Low Stray Inductance
Low Saturation Voltage
Ultra Low loss
HI-REL Power Terminals
Lead Free, Compliant With RoHS Requirement

Absolute Maximum Ratings (T_C = 25°C unless otherwise specified)

Symbol	Description	Values	Units	
V _{CES}	Collector - Emitter Voltage	1200	V	
V _{GES}	Gate-Emitter Voltage	±20	V	
I _C	DC Collector Current	T _C =25°C	300	A
		T _C =80°C	200	A
I _{CM}	Repetitive Peak Collector Current	t _p =1ms	400	A
P _{tot}	Power Dissipation Per IGBT	1150	W	
T _J	Junction Temperature Range	40 to +150	°C	
T _{STG}	Storage Temperature Range	40 to +125	°C	
Viso	Insulation Test Voltage	AC, t=1min	3000	V
Mounting Torque	Power Terminals Screw: M6	5±15%	N*m	
	Mounting Screw:M6	5±15%	N*m	

Notes :

(1) Repetitive Rating: Pulse width limited by max. junction temperature



Electrical Characteristics of IGBT ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Item	Conditions	Values			Units
			Min.	Typ.	Max.	
OFF Characteristics						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	1200			V
I_{CES}	Collector Leakage Current	$V_{CE}=1200V, V_{GE}=0V, T_J=25^\circ\text{C}$		0.4	1	mA
		$V_{CE}=1200V, V_{GE}=0V, T_J=125^\circ\text{C}$			5	mA
I_{GES}	Gate Leakage Current	$V_{CE}=0V, V_{GE}=\pm 20V$	-400		400	nA
ON Characteristics						
$V_{GE(th)}$	Gate - Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=6mA$	5.5	6	6.5	V
$V_{CE(sat)}$	Collector – Emitter Saturation Voltage	$I_C=150A, V_{GE}=15V, T_J=25^\circ\text{C}$		2		V
		$I_C=150A, V_{GE}=15V, T_J=125^\circ\text{C}$		2.4		V
Dynamic Characteristics						
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V, f=1MHz$		12.5		nF
C_{oes}	Output Capacitance			1.04		nF
C_{res}	Reverse Transfer Capacitance			0.7		nF
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=200A, R_G=5\Omega, V_{GE}=\pm 15V, T_J=25^\circ\text{C}$ Inductive Load		125		ns
t_r	Rise Time			60		ns
$t_{d(off)}$	Turn-off Delay Time			420		ns
T_f	Fall Time			60		ns
E_{on}	Turn-on Switching Loss	$V_{CC}=600V, I_C=200A, R_G=5\Omega, V_{GE}=\pm 15V$ Inductive Load	$T_J=25^\circ\text{C}$	17		mJ
			$T_J=125^\circ\text{C}$	24.8		mJ
E_{off}	Turn-off Switching Loss		$T_J=25^\circ\text{C}$	13.6		mJ
			$T_J=125^\circ\text{C}$	21.6		mJ
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=200A, R_G=5\Omega, V_{GE}=\pm 15V, T_J=125^\circ\text{C}$ Inductive Load		135		ns
t_r	Rise Time			60		ns
$t_{d(off)}$	Turn-off Delay Time			490		ns
T_f	Fall Time			75		ns
Q_{ge}	Gate Charge	$V_{CC}=600V, I_C=150A, V_{GE}=\pm 15V$		2100		nC
RBSOA	Reverse Bias Safe Operating Area	$I_C = 200A, V_{CC} = 600V, V_p = 1200V, R_g = 10\Omega, V_{GE} = +15V \text{ to } 0V, T_J = 150^\circ\text{C}$	Trapezoid			
SCSOA	Short Circuit Safe Operating Area	$V_{CC} = 600V, V_{GE} = 15V, T_J = 150^\circ\text{C}$	10			μs



Electrical Characteristics of FWD (T_C = 25°C unless otherwise specified)

Symbol	Item	Conditions	Min.	Typ.	Max.	Units
V _{FM}	Forward Voltage	I _F = 150A, V _{GE} = 0V	T _J = 25°C	2.0	2.44	V
			T _J = 125°C	1.7	2.20	
t _{rr}	Reverse Recovery Time	I _F = 100A, R _g = 10Ω, di/dt = 1000A/μs, V _{rr} = 600V, V _{GE} = ±15V	T _J = 25°C	230		ns
			T _J = 125°C	260		
I _{rr}	Peak Reverse Recovery Current	I _F = 100A, R _g = 10Ω, di/dt = 1000A/μs, V _{rr} = 600V, V _{GE} = ±15V	T _J = 25°C	90		A
			T _J = 125°C	110		
Q _{rr}	Reverse Recovery Charge	I _F = 100A, R _g = 10Ω, di/dt = 1000A/μs, V _{rr} = 600V, V _{GE} = ±15V	T _J = 25°C	10.5		μC
			T _J = 125°C	13.5		

Thermal Resistance Characteristics

Symbol	Description	Min.	Typ.	Max.	Units
R _{θJC}	Junction-To-Case (IGBT Part, Per Leg)			0.09	°C/W
R _{θJC}	Junction-To-Case (Diode Part, Per Leg)			0.22	°C/W
Mt	Power Terminals Screw:M5	3		5	N·m
Ms	Mounting Screw:M6	3		5	N·m
Weight	Weight Of Module			300	g

Performance Curves

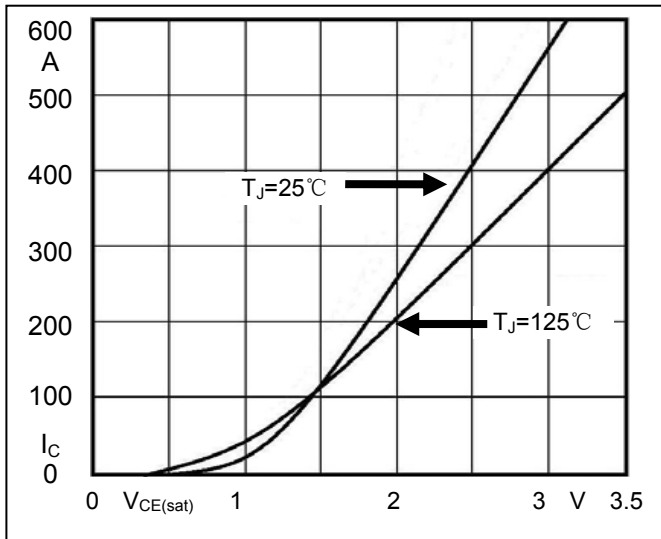


Fig1. Typical Output Characteristics

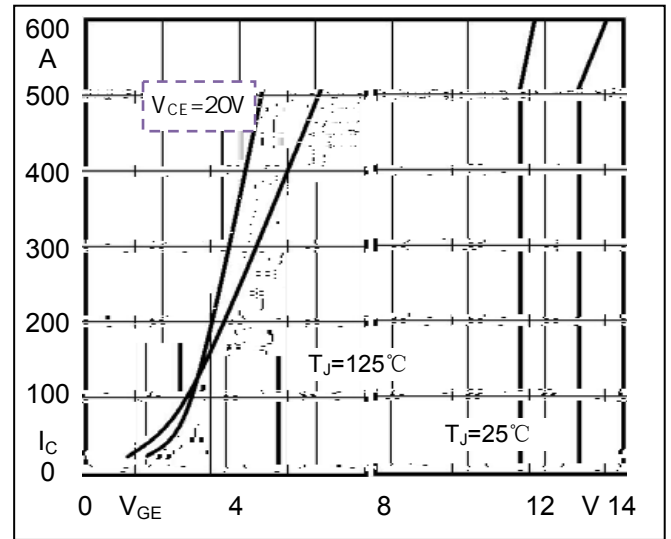


Fig2. Typical Transfer Characteristics

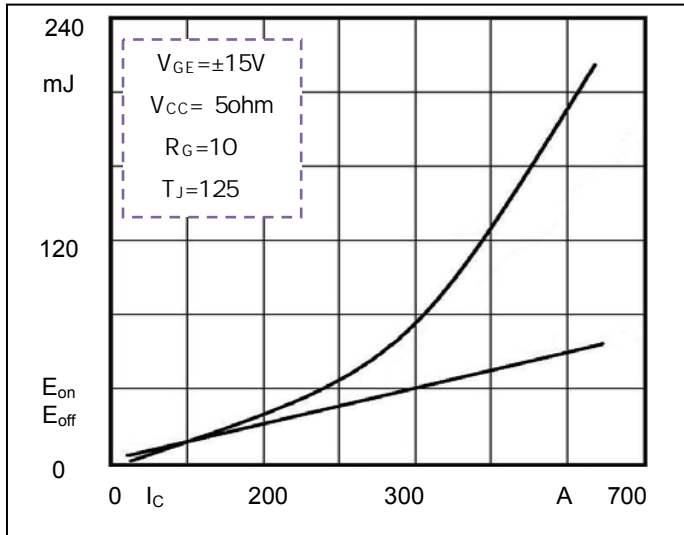


Fig3. Switching Energy vs. Collector Current

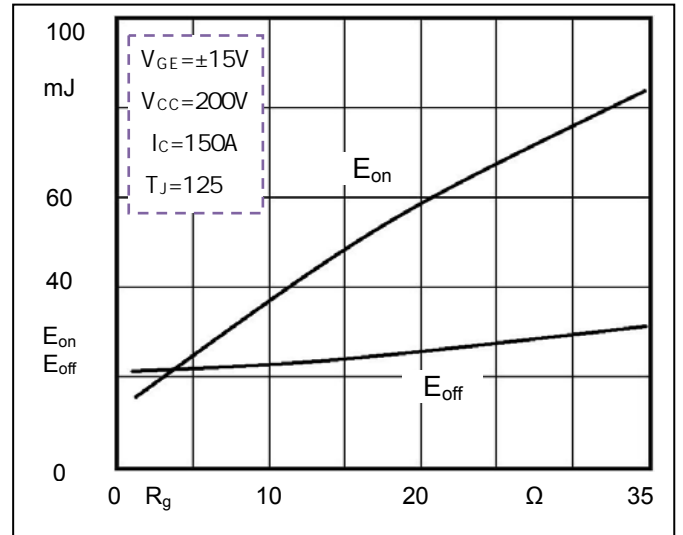


Fig4. Switching Energy vs. Gate Resistor

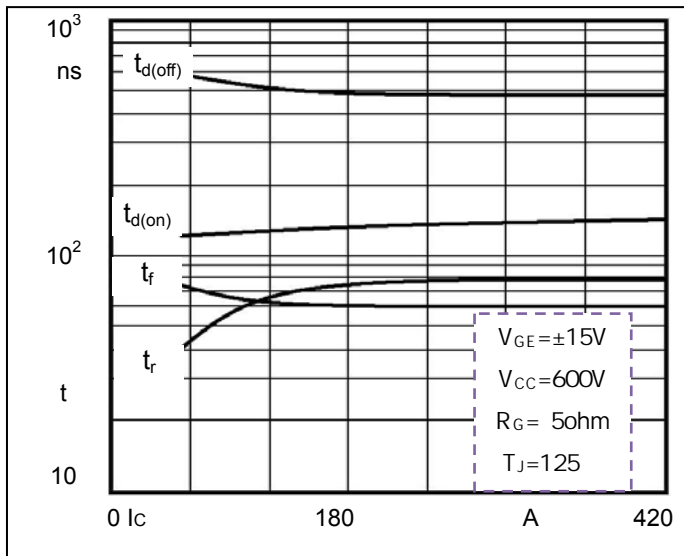


Fig5. Switching Times vs. Collector Current

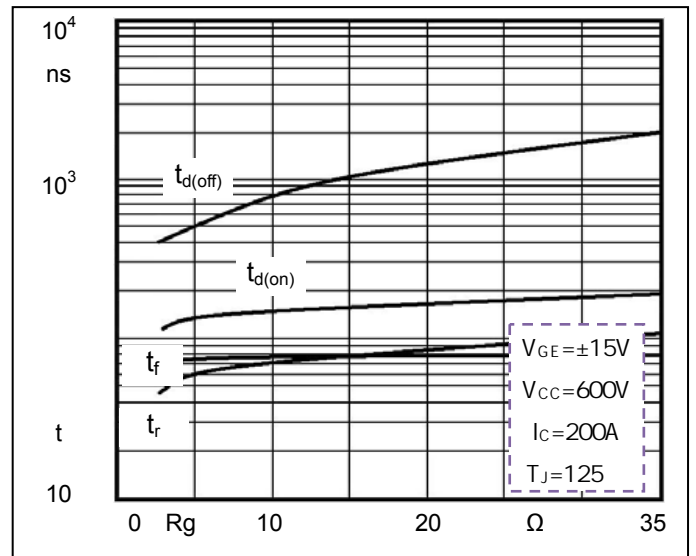


Fig6. Switching Times vs. Gate Resistor

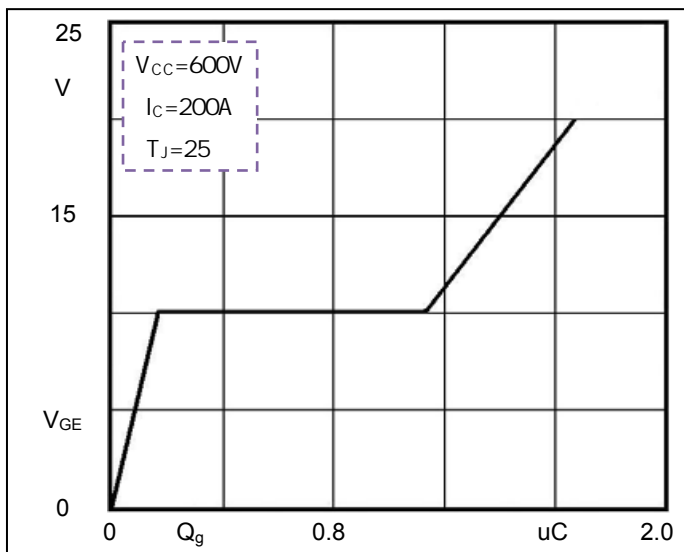


Fig7. Gate Charge characteristics

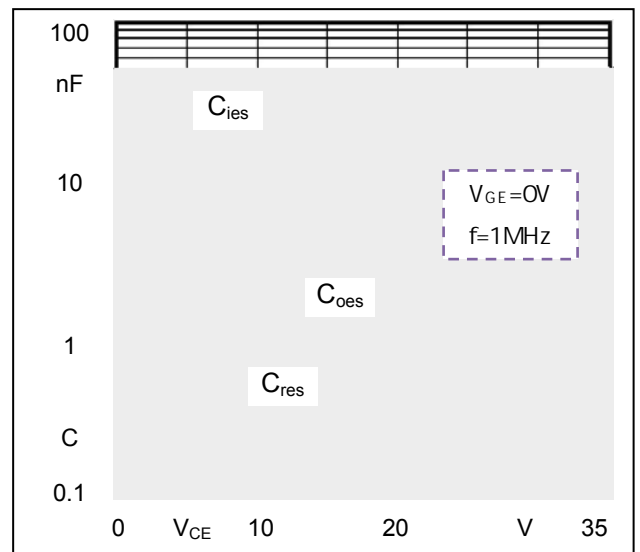


Fig8. Typical Capacitances vs. V_{CE}

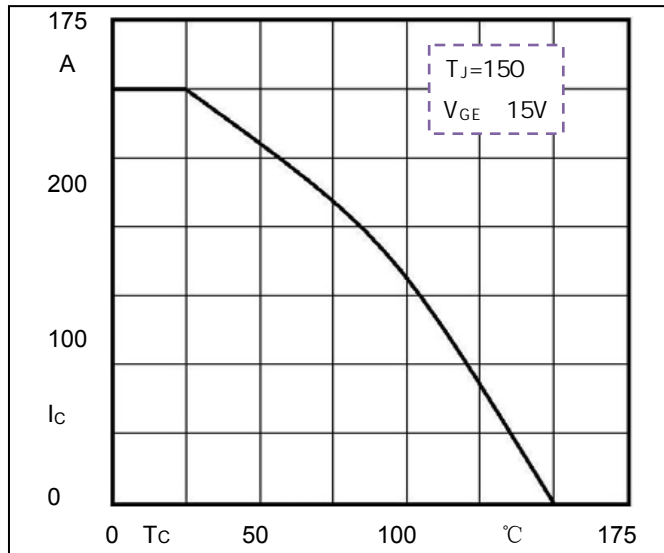


Fig9. Rated Current vs. T_c

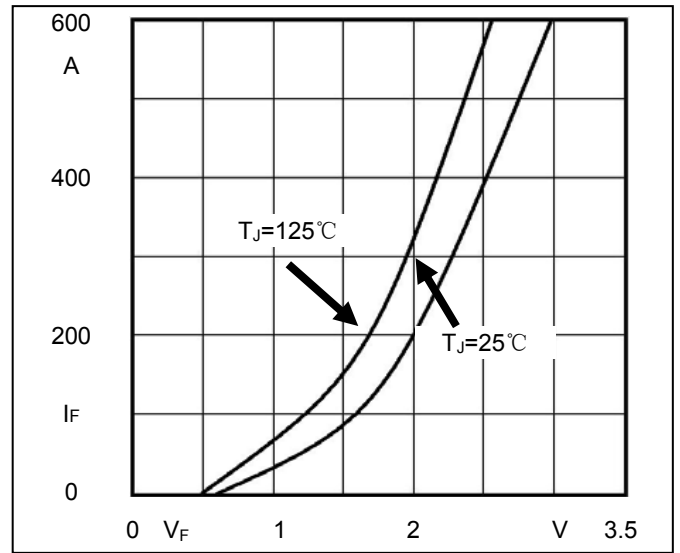


Fig10. Diode Forward Characteristics

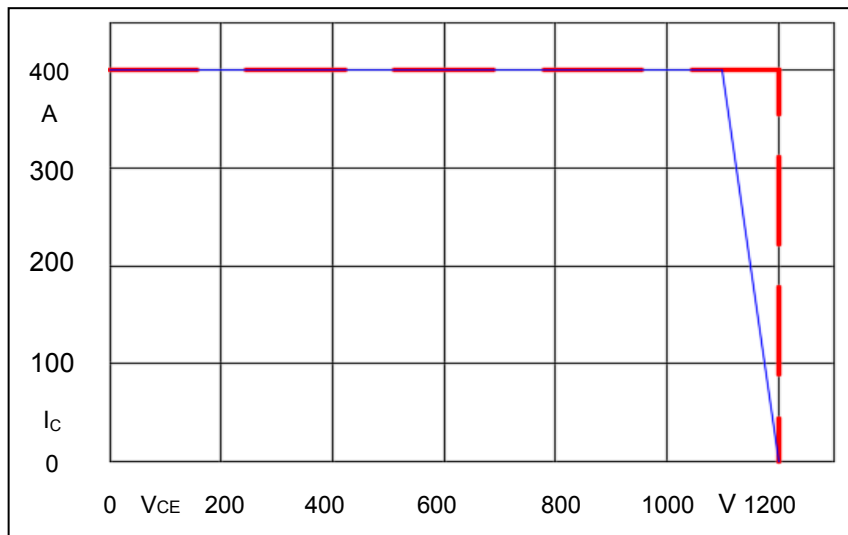


Fig11. Reverse Bias Safe Operation Area (RBSOA)

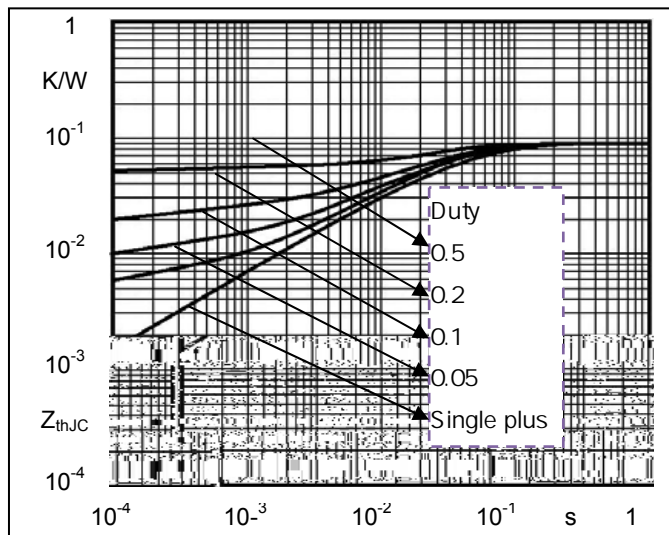


Fig12. Transient Thermal Impedance of IGBT

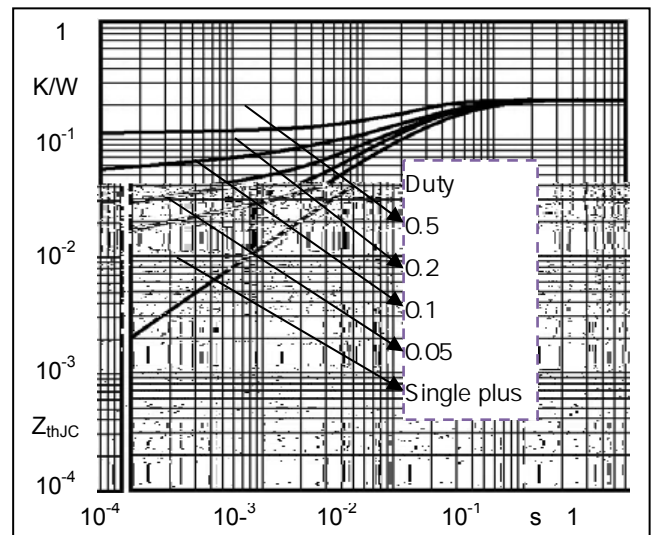
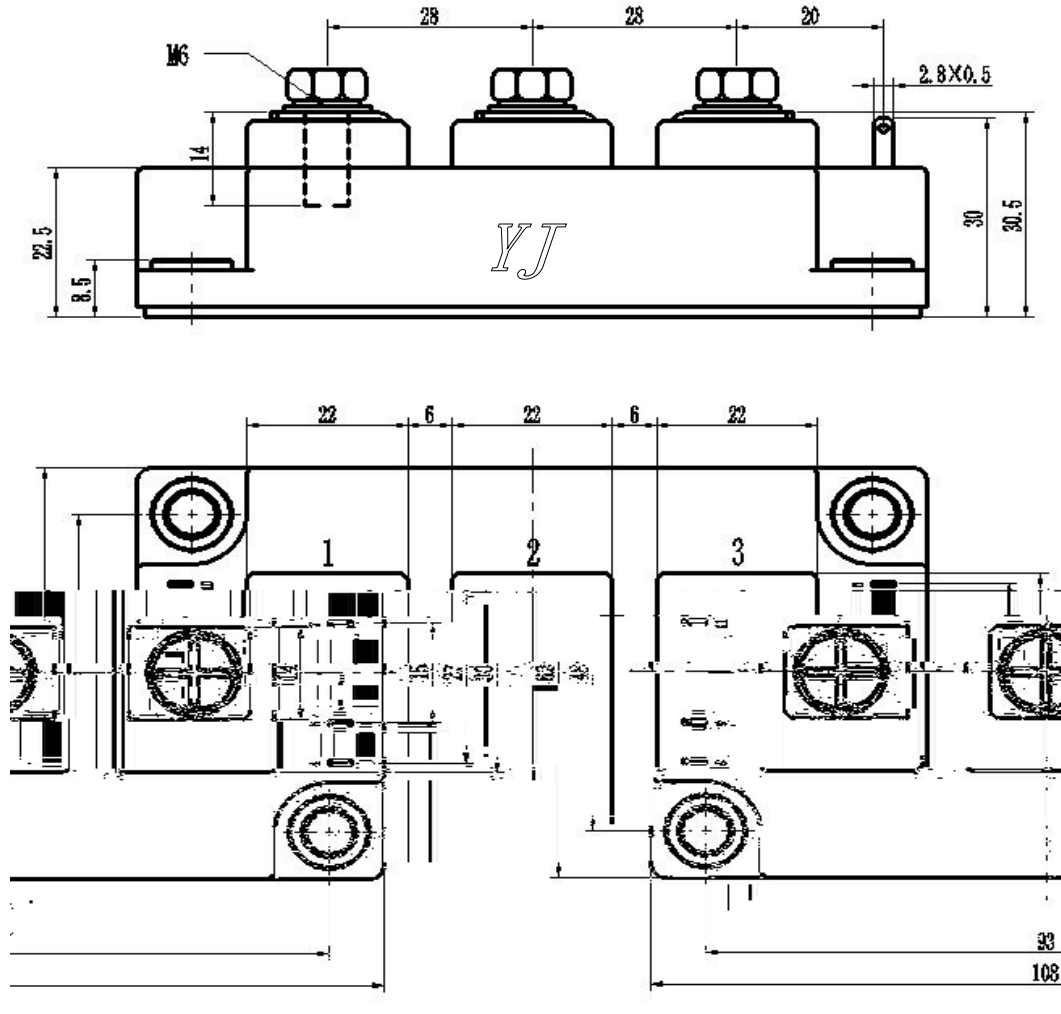


Fig13. Transient Thermal Impedance of Diode

Package Outline Information

CASE: C2



Dimensions in mm